# 74VHC595; 74VHCT595

# 8-bit serial-in/serial-out or parallel-out shift register with output latches

Rev. 3 — 25 June 2020

Product data sheet

# 1. General description

The 74VHC595; 74VHCT595 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74VHC595; 74VHCT595 are 8-stage serial shift registers with a storage register and 3-state outputs. The shift registers have separate clocks.

Data is shifted on the positive-going transitions of the shift register clock input (SHCP). The data in each register is transferred to the storage register on a positive-going transition of the storage register clock input (STCP). If both clocks are connected together, the shift register will always be one clock pulse ahead of the storage register.

The shift register has a serial input (DS) and a serial standard output (Q7S) for cascading. It is also provided with asynchronous reset (active LOW) for all 8 shift register stages. The storage register has 8 parallel 3-state bus driver outputs. Data in the storage register appears at the output whenever the output enable input  $(\overline{OE})$  is LOW.

### 2. Features and benefits

- · Balanced propagation delays
- All inputs have Schmitt-trigger action
- Inputs accept voltages higher than V<sub>CC</sub>
- Input levels:
  - For 74VHC595: CMOS level
  - For 74VHCT595: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

# 3. Applications

- Serial-to-parallel data conversion
- Remote control holding register

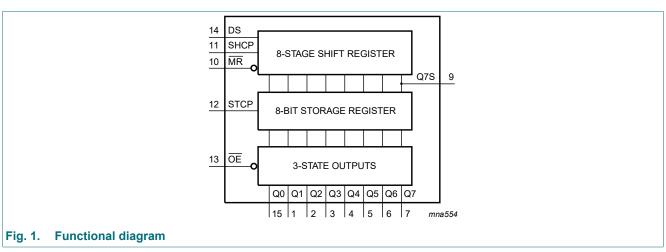


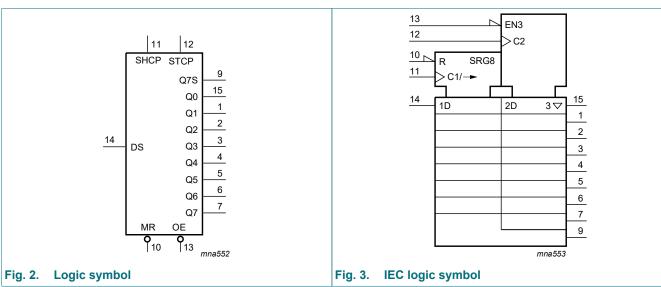
# 4. Ordering information

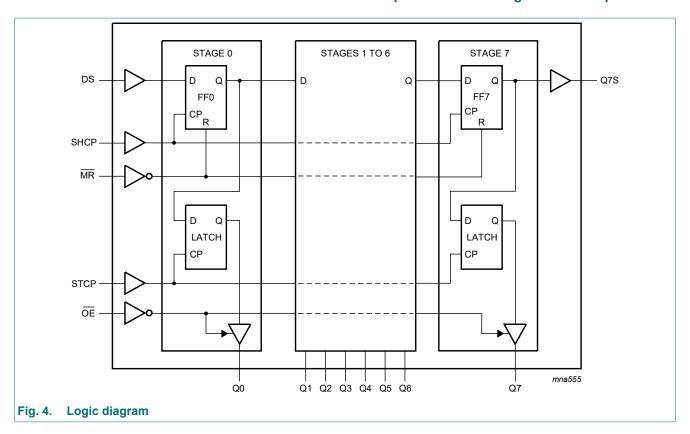
**Table 1. Ordering information** 

Type number	Package	Package										
	Temperature range	Name	Description	Version								
74VHC595D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1								
74VHCT595D			body width 3.9 mm									
74VHC595PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1								
74VHCT595PW			body width 4.4 mm									
74VHC595BQ	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal	SOT763-1								
74VHCT595BQ		enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm										

# 5. Functional diagram

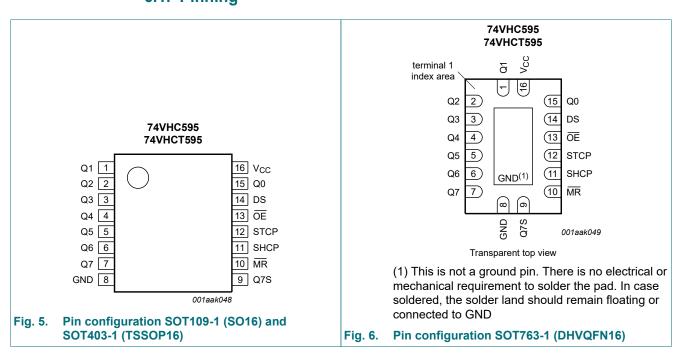






# 6. Pinning information

### 6.1. Pinning



# 6.2. Pin description

Table 2. Pin description

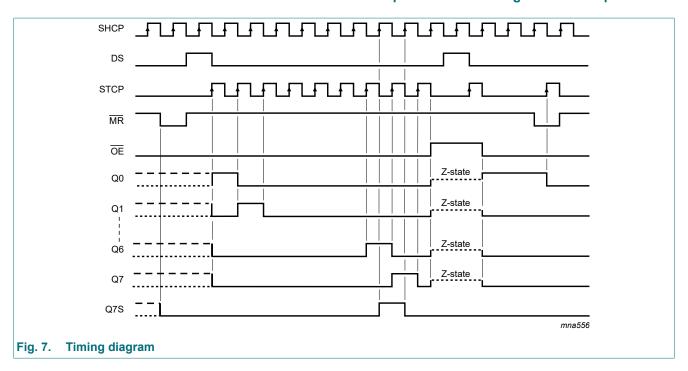
Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
Q7S	9	serial data output
MR	10	master reset (active LOW)
SHCP	11	shift register clock input
STCP	12	storage register clock input
ŌE	13	output enable input (active LOW)
DS	14	serial data input
V <sub>CC</sub>	16	supply voltage

# 7. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ state; \ L = LOW \ voltage \ state; \ \uparrow = LOW-to-HIGH \ transition; \ X = don't \ care; \ NC = no \ change; \ Z = high-impedance \ OFF-state.$ 

Contro	ol .			Input	Outpu	t	Function
SHCP	STCP	ŌΕ	MR	DS	Q7S	Qn	
Χ	Х	L	L	Х	L	NC	a LOW-level on MR only affects the shift registers
Χ	1	L	L	Х	L	L	empty shift register loaded into storage register
X	Х	Н	L	Х	L	Z	shift register clear; parallel outputs in high-impedance OFF-state
<b>↑</b>	Х	L	Н	Н	Q6S	NC	logic HIGH-level shifted into shift register stage 0. Contents of all shift register stages shifted through, e.g. previous state of stage 6 (internal Q6S) appears on the serial output (Q7S).
X	1	L	Н	Х	NC	QnS	contents of shift register stages (internal QnS) are transferred to the storage register and parallel output stages
<b>↑</b>	<b>↑</b>	L	Н	Х	Q6S	QnS	contents of shift register shifted through; previous contents of the shift register is transferred to the storage register and the parallel output stages



# 8. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V}$ [1]	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-20	+20	mA
Io	output current	$V_O = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-25	+25	mA
Icc	supply current		-	+75	mA
$I_{GND}$	ground current		-75	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C to } +125  ^{\circ}\text{C}$ [2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>[2]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.

# 9. Recommended operating conditions

**Table 5. Operating conditions** 

Symbol	Parameter	Conditions	7	4VHC59	5	74	Unit		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	100	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	20	-	-	20	ns/V

### 10. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C	;	-40 °C to	o +85 °C	-40 °C to +125 °C  Min Max  1.5 - 2.1 - 3.85 0.5 - 0.9 - 1.65  1.9 - 2.9 -		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74VHC5	95			'						
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		$I_{O}$ = -8.0 mA; $V_{CC}$ = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I <sub>O</sub> = 8.0 mA; V <sub>CC</sub> = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.25	-	±2.5	-	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
C <sub>I</sub>	input capacitance		-	3	10	-	10	-	10	pF

Symbol	Parameter	Conditions		25 °C	;	-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74VHCT	595	,		<u> </u>				'		•
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.25	-	±2.5	-	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_1 = V_{CC} - 2.1 \text{ V}$ ; other inputs at $V_{CC}$ or GND; $I_0 = 0 \text{ A}$ ; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
Cı	input capacitance		-	3	10	-	10	-	10	pF

# 11. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 13.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74VHC5	95							I	1	
t <sub>pd</sub>	propagation	SHCP to Q7S; see Fig. 8 [2]								
-	delay	V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.7	13.0	1.0	15.0	1.0	16.5	ns
		C <sub>L</sub> = 50 pF	-	7.7	16.5	1.0	18.5	1.0	20.1	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.0	8.2	1.0	9.4	1.0	10.5	ns
		C <sub>L</sub> = 50 pF	-	5.4	10.0	1.0	11.4	1.0	12.5	ns
		STCP to Qn; see Fig. 9 [2]								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.9	11.9	1.0	13.5	1.0	15.0	ns
		C <sub>L</sub> = 50 pF	-	7.7	15.4	1.0	17.0	1.0	18.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.2	7.4	1.0	8.5	1.0	9.5	ns
		C <sub>L</sub> = 50 pF	-	5.5	9.0	1.0	10.5	1.0	11.5	ns
		MR to Q7S; see <u>Fig. 11</u> [3]								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.9	12.8	1.0	13.7	1.0	15.0	ns
		C <sub>L</sub> = 50 pF	-	7.4	16.3	1.0	17.2	1.0	18.7	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.4	8.0	1.0	9.1	1.0	10.0	ns
		C <sub>L</sub> = 50 pF	-	5.6	10.0	1.0	11.1	1.0	12.0	ns
t <sub>en</sub>	enable time	OE to Qn; see Fig. 12 [4]								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.6	11.5	1.0	13.5	1.0	15.0	ns
		C <sub>L</sub> = 50 pF	-	7.4	15.0	1.0	17.0	1.0	18.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	4.0	8.6	1.0	10.0	1.0	11.0	ns
		C <sub>L</sub> = 50 pF	-	5.3	10.6	1.0	12.0	1.0	13.0	ns
t <sub>dis</sub>	disable time	OE to Qn; see Fig. 12 [5]								
		V <sub>CC</sub> = 3.0 V to 3.6 V								
		C <sub>L</sub> = 15 pF	-	5.4	11.0	1.0	13.0	1.0	14.5	ns
		C <sub>L</sub> = 50 pF	-	8.7	15.7	1.0	16.2	1.0	17.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V								
		C <sub>L</sub> = 15 pF	-	3.8	8.0	1.0	9.5	1.0	10.5	ns
		C <sub>L</sub> = 50 pF	-	5.8	10.3	1.0	11.0	1.0	12.0	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
f <sub>max</sub>	maximum frequency	SHCP or STCP; see Fig. 8 and Fig. 9								
		V <sub>CC</sub> = 3.0 V to 3.6 V	80	125	-	60	-	40	-	MHz
		V <sub>CC</sub> = 4.5 V to 5.5 V	130	170	-	110	-	90	-	MHz
t <sub>W</sub>	pulse width	SHCP HIGH or LOW; see Fig. 8								
		V <sub>CC</sub> = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
		STCP HIGH or LOW; see Fig. 9								
		V <sub>CC</sub> = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
		MR LOW; see Fig. 11								
		V <sub>CC</sub> = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.0	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t <sub>su</sub>	set-up time	DS to SHCP; see Fig. 10								
		V <sub>CC</sub> = 3.0 V to 3.6 V	3.5	-	-	3.5	-	3.5	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	3.0	-	-	3.0	-	3.0	-	ns
		SHCP to STCP; see Fig. 9								
		V <sub>CC</sub> = 3.0 V to 3.6 V	8.5	-	-	8.5	-	8.5	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.0	-	ns
t <sub>h</sub>	hold time	DS to SHCP; see Fig. 10								
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.5	-	-	1.5	-	1.5	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	ns
t <sub>rec</sub>	recovery	MR to SHCP; see Fig. 11								
	time	V <sub>CC</sub> = 3.0 V to 3.6 V	3.0	-	-	3.0	-	3.0	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	2.5	-	-	2.5	-	2.5	-	ns
C <sub>PD</sub>	power dissipation capacitance	$f_i$ = 1 MHz; [6] $V_I$ = GND to $V_{CC}$ ; all 9 outputs switching	-	180	-	-	-	-	-	pF

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
74VHCT	595; V <sub>CC</sub> = 4.	5 V to 5.5 V									
t <sub>pd</sub>	propagation	SHCP to Q7S; see Fig. 8	[2]								
	delay	C <sub>L</sub> = 15 pF		-	3.8	8.2	1.0	9.0	1.0	10.0	ns
		C <sub>L</sub> = 50 pF		-	5.2	10.0	1.0	11.0	1.0	12.0	ns
		STCP to Qn; see Fig. 9	[2]								
		C <sub>L</sub> = 15 pF		-	4.0	7.4	1.0	8.5	1.0	9.5	ns
		C <sub>L</sub> = 50 pF		-	5.3	9.0	1.0	10.5	1.0	11.5	ns
		MR to Q7S; see Fig. 11	[3]								
		C <sub>L</sub> = 15 pF		-	4.6	8.2	1.0	9.5	1.0	10.5	ns
		C <sub>L</sub> = 50 pF		-	5.8	10.5	1.0	11.5	1.0	12.5	ns
t <sub>en</sub>	enable time	OE to Qn; see Fig. 12	[4]								
		C <sub>L</sub> = 15 pF		-	4.8	9.0	1.0	11.0	1.0	12.0	ns
		C <sub>L</sub> = 50 pF		-	6.2	11.6	1.0	13.0	1.0	14.5	ns
t <sub>dis</sub>	disable time	OE to Qn; see Fig. 12	[5]								
		C <sub>L</sub> = 15 pF		-	3.6	6.9	1.0	8.0	1.0	9.0	ns
		C <sub>L</sub> = 50 pF		-	5.8	10.3	1.0	11.0	1.0	12.0	ns
f <sub>max</sub>	maximum frequency	SHCP and STCP; see Fig. 8 and Fig. 9		130	170	-	110	-	90	-	MHz
t <sub>W</sub>	pulse width	SHCP HIGH or LOW; see Fig. 8		5.0	-	-	5.0	-	5.0	-	ns
		STCP HIGH or LOW; see Fig. 9		5.0	-	-	5.0	-	5.0	-	ns
		MR LOW; see Fig. 11		5.0	-	-	5.0	-	5.0	-	ns
t <sub>su</sub>	set-up time	DS to SHCP; see Fig. 10		3.0	-	-	3.0	-	3.0	-	ns
		SHCP to STCP; see Fig. 9		5.0	-	-	5.0	-	5.0	-	ns
t <sub>h</sub>	hold time	DS to SHCP; see Fig. 10		2.0	-	-	2.0	-	2.0	-	ns
t <sub>rec</sub>	recovery time	MR to SHCP; see Fig. 11		3.0	-	-	3.0	-	3.0	-	ns
C <sub>PD</sub>	power dissipation capacitance	$\begin{split} f_i &= 1 \text{ MHz;} \\ V_I &= \text{GND to V}_{CC}; \\ \text{all 9 outputs switching} \end{split}$	[6]	-	190	-	-	-	-	-	pF

- Typical values are measured at nominal supply voltage.
- [2]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- [3]
- $t_{pd}$  is the same as  $t_{PHL}$  only.  $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ . [4]
- [5]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [6]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

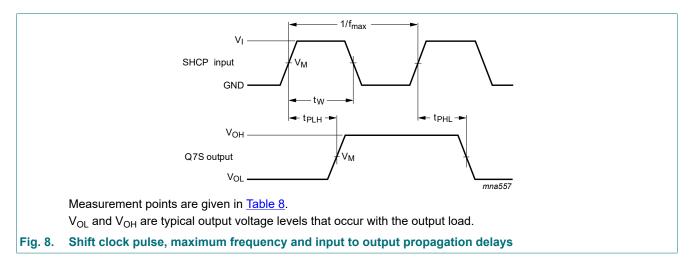
 $f_i$  = input frequency in MHz;

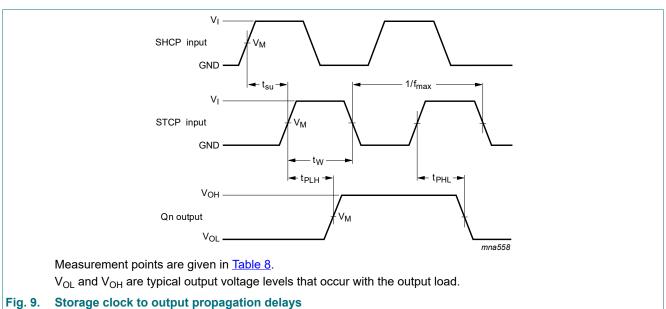
$$\begin{split} &f_o = \text{output frequency in MHz;} \\ &\Sigma(C_L \ x \ V_{CC} \ ^2 \ x \ f_o) = \text{sum of outputs;} \end{split}$$

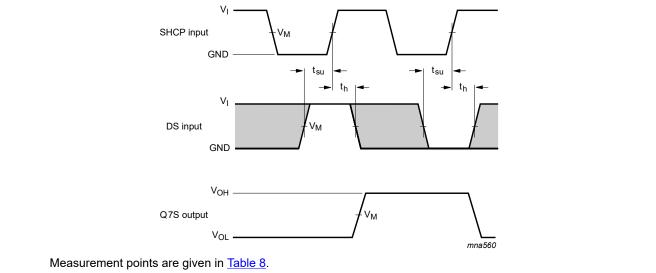
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V.

#### 11.1. Waveforms and test circuit



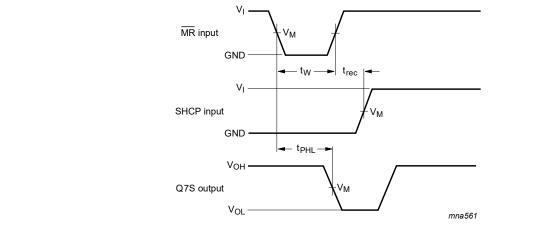




The shaded areas indicate when the input is permitted to change for predictable output performance.

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

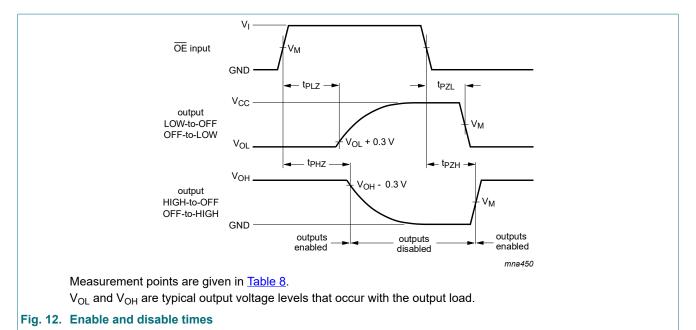
Fig. 10. Data set-up and hold times



Measurement points are given in Table 8.

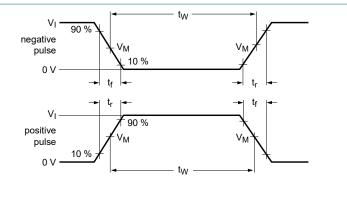
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

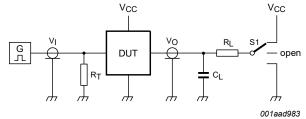
Fig. 11. Master reset to output propagation delays



**Table 8. Measurement points** 

Table of Modern Control points		
Туре	Input	Output
	V <sub>M</sub>	$V_{M}$
74VHC595	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74VHCT595	1.5 V	0.5V <sub>CC</sub>





Test data is given in Table 9.

Definitions for test circuit:

 $C_L$  = load capacitance including jig and probe capacitance.

R<sub>L</sub> = load resistance.

 $R_T$  = termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

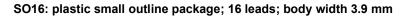
S1 = test selection switch.

Fig. 13. Test circuit for measuring switching times

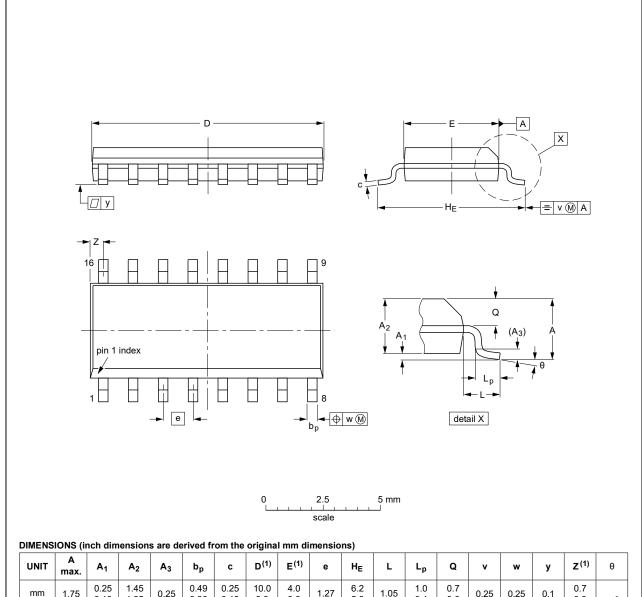
Table 9. Test data

Туре	Input		Load		S1 position		
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$
74VHC595	V <sub>CC</sub>	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74VHCT595	3.0 V	≤ 3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>

# 12. Package outline



SOT109-1



	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	nches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

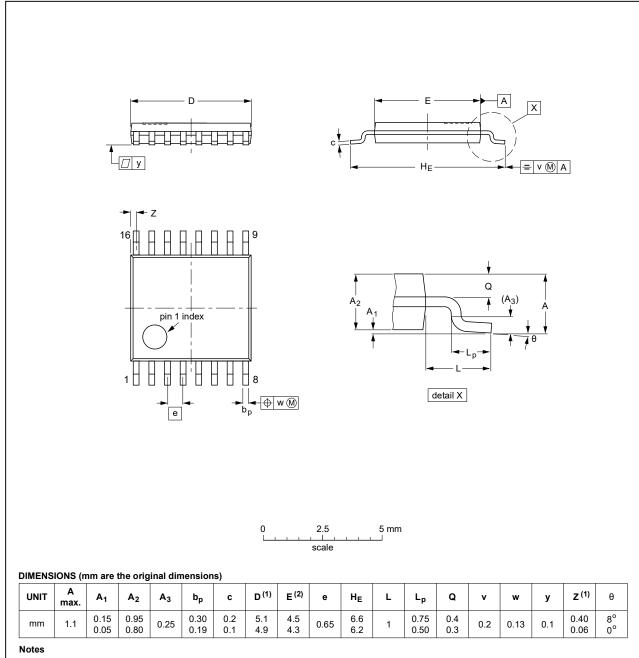
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19	

Fig. 14. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig. 15. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

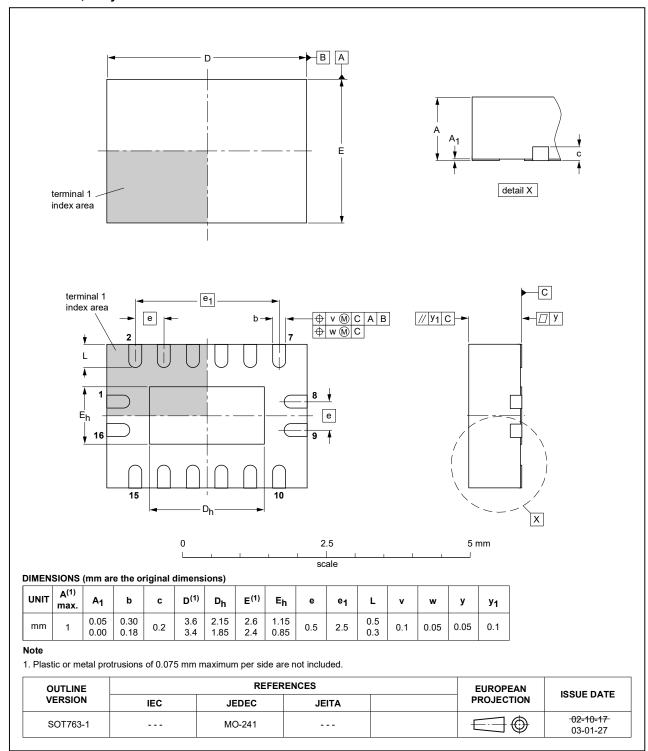


Fig. 16. Package outline SOT763-1 (DHVQFN16)

# 13. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74VHC_VHCT595 v.3	20200625	Product data sheet	-	74VHC_VHCT595 v.2			
Modifications:	Nexperia.  • Legal texts have  • Fig. 7: updated (\$  • Table 4: Derating	s data sheet has been re been adapted to the ne SHCP waveform added; values for P <sub>tot</sub> total pov ns for I <sub>OZ</sub> corrected.	w company name whe				
74VHC_VHCT595 v.2	20120704	Product data sheet	-	74VHC_VHCT595 v.1			
Modifications:	Added GND in th	Added GND in the pin configuration drawing DHVQFN16 (errata)					
74VHC_VHCT595 v.1	20090811	Product data sheet	-	-			

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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